

## CMOS HEX VOLTAGE-LEVEL SHIFTER FOR TTL-TO-CMOS or CMOS-TO-CMOS OPERATION

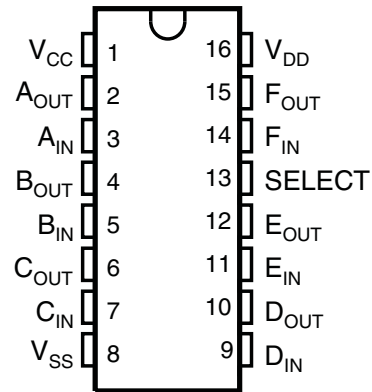
### FEATURES

- Independence of Power-Supply Sequence Considerations –  $V_{CC}$  Can Exceed  $V_{DD}$ ; Input Signals Can Exceed Both  $V_{CC}$  and  $V_{DD}$
- Up and Down Level-Shifting Capability
- Shiftable Input Threshold for Either CMOS or TTL Compatibility
- Standardized Symmetrical Output Characteristics
- 100% Tested for Quiescent Current at 20 V
- Maximum Input Current of 1  $\mu$ A at 18 V Over Full Package-Temperature Range: 100 nA at 18 V and 25°C
- 5 V, 10 V, and 15 V Parametric Ratings
- Meets All Requirements of JEDEC Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

### SUPPORTS DEFENSE, AEROSPACE, AND MEDICAL APPLICATIONS

- Controlled Baseline
- One Assembly/Test Site
- One Fabrication Site
- Available in Military (–55°C/125°C) Temperature Range<sup>(1)</sup>
- Extended Product Life Cycle
- Extended Product-Change Notification
- Product Traceability

(TOP VIEW)



(1) Additional temperature ranges are available – contact factory

### DESCRIPTION

CD4504B hex voltage level-shifter consists of six circuits which shift input signals from the  $V_{CC}$  logic level to the  $V_{DD}$  logic level. To shift TTL signals to CMOS logic levels, the SELECT input is at the  $V_{CC}$  HIGH logic state. When the SELECT input is at a LOW logic state, each circuit translates signals from one CMOS level to another.

### ORDERING INFORMATION<sup>(1)</sup>

| $T_A$          | PACKAGE <sup>(2)</sup> |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------------------|--------------|-----------------------|------------------|
| –55°C to 125°C | TSSOP – PW             | Reel of 2000 | CD4504BMPWREP         | 4504BEP          |

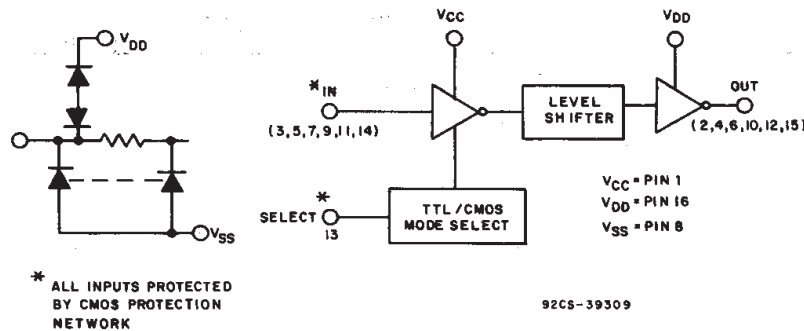
(1) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).

(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

**FUNCTIONAL BLOCK DIAGRAM**



**ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted)

|                  |                                                                                                                   | MIN                               | MAX                   | UNIT                                  |
|------------------|-------------------------------------------------------------------------------------------------------------------|-----------------------------------|-----------------------|---------------------------------------|
| V <sub>DD</sub>  | DC supply-voltage range, voltages referenced to V <sub>SS</sub> terminal                                          | –0.5                              | +20                   | V                                     |
|                  | Input voltage range, all inputs                                                                                   | –0.5                              | V <sub>CC</sub> + 0.5 | V                                     |
|                  | DC input current, any one input                                                                                   |                                   | ±10                   | mA                                    |
| P <sub>D</sub>   | Power dissipation per package                                                                                     | T <sub>A</sub> = –55°C to +100°C  |                       | 500 mW                                |
|                  |                                                                                                                   | T <sub>A</sub> = +100°C to +125°C |                       | Derate Linearly at 12 mW/°C to 200 nW |
|                  | Device dissipation per output transistor, for T <sub>A</sub> = full package-temperature range (all package types) |                                   | 100                   | mW                                    |
| T <sub>A</sub>   | Operating temperature range                                                                                       | –55                               | +125                  | °C                                    |
| θ <sub>JA</sub>  | Package thermal impedance <sup>(1)</sup>                                                                          |                                   | 91.1                  | °C/W                                  |
| T <sub>stg</sub> | Storage temperature range                                                                                         | –85                               | +150                  | °C                                    |
|                  | Lead temperature (during soldering), at distance 1/16 ± 1/32 inch (1.59 ± 0.79 mm) from case for 10 s max         |                                   | +265                  | °C                                    |

(1) The package thermal impedance is calculated in accordance with JESD 51-7.

## STATIC ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

| CHARACTERISTIC                                                                         |           | CONDITIONS            |                        |                        |                        | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |       |                   |      | UNIT |
|----------------------------------------------------------------------------------------|-----------|-----------------------|------------------------|------------------------|------------------------|---------------------------------------|-------|-------|-------|-------|-------------------|------|------|
|                                                                                        |           | V <sub>O</sub><br>(V) | V <sub>IN</sub><br>(V) | V <sub>CC</sub><br>(V) | V <sub>CC</sub><br>(V) | −55                                   | −40   | +85   | +125  | +25   |                   |      |      |
|                                                                                        |           |                       |                        |                        |                        |                                       |       |       |       | MIN   | TYP               | MAX  |      |
| Quiescent device current,<br>I <sub>DD</sub> max and I <sub>CC</sub> in CMOS-CMOS mode |           |                       | 0, 5                   | 5                      | 5                      | 1.5                                   | 1.5   | 1.5   | 1.5   |       | 0.02              | 1.5  | mA   |
|                                                                                        |           |                       | 0, 10                  | 5                      | 10                     | 2                                     | 2     | 2     | 2     |       | 0.02              | 2    |      |
|                                                                                        |           |                       | 0, 15                  | 5                      | 15                     | 4                                     | 4     | 120   | 120   |       | 0.02              | 4    | μA   |
|                                                                                        |           |                       | 0, 20                  | 5                      | 20                     | 20                                    | 20    | 600   | 600   |       | 0.04              | 20   |      |
| Quiescent device current,<br>I <sub>CC</sub> max TTL-CMOS mode                         |           |                       | 0, 5                   | 5                      | 5                      | 5                                     | 5     | 6     | 6     |       | 2.5               | 5    | mA   |
|                                                                                        |           |                       | 0, 10                  | 5                      | 10                     | 5                                     | 5     | 6     | 6     |       | 2.5               | 5    |      |
|                                                                                        |           |                       | 0, 15                  | 5                      | 15                     | 5                                     | 5     | 6     | 6     |       | 2.5               | 5    |      |
| Output low (sink) current,<br>I <sub>OL</sub> min                                      |           | 0.4                   | 0, 5                   |                        | 5                      | 0.64                                  | 0.61  | 0.42  | 0.36  | 0.51  | 1                 |      | mA   |
|                                                                                        |           | 0.5                   | 0, 10                  |                        | 10                     | 1.6                                   | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               |      |      |
|                                                                                        |           | 1.5                   | 0, 15                  |                        | 15                     | 4.2                                   | 4     | 2.8   | 2.4   | 3.4   | 6.8               |      |      |
| Output high (source) current,<br>I <sub>OH</sub> min                                   |           | 4.6                   | 0, 5                   |                        | 5                      | −0.64                                 | −0.61 | −0.42 | −0.36 | −0.51 | −1                |      |      |
|                                                                                        |           | 2.5                   | 0, 5                   |                        | 5                      | −2                                    | −1.8  | −1.3  | −1.15 | −1.6  | −3.2              |      |      |
|                                                                                        |           | 9.5                   | 0, 10                  |                        | 10                     | −1.6                                  | −1.5  | −1.1  | −0.9  | −1.3  | −2.6              |      |      |
|                                                                                        |           | 13.5                  | 0, 15                  |                        | 15                     | −4.2                                  | −4    | −2.8  | −2.4  | −3.4  | −6.8              |      |      |
| Output voltage:<br>low-level, V <sub>OL</sub> max                                      |           |                       | 0, 5                   |                        | 5                      | 0.05                                  |       |       |       |       | 0                 | 0.05 | V    |
|                                                                                        |           |                       | 0, 10                  |                        | 10                     | 0.05                                  |       |       |       |       | 0                 | 0.05 |      |
|                                                                                        |           |                       | 0, 15                  |                        | 15                     | 0.05                                  |       |       |       |       | 0                 | 0.05 |      |
| Output voltage:<br>high-level, V <sub>OH</sub> min                                     |           |                       | 0, 5                   |                        | 5                      | 4.95                                  |       |       |       | 4.95  | 5                 |      |      |
|                                                                                        |           |                       | 0, 10                  |                        | 10                     | 9.95                                  |       |       |       | 9.95  | 10                |      |      |
|                                                                                        |           |                       | 0, 15                  |                        | 15                     | 14.95                                 |       |       |       | 14.95 | 15                |      |      |
| Input low voltage,<br>V <sub>IL</sub> max <sup>(1)</sup>                               | TTL-CMOS  | 1                     |                        | 5                      | 10                     | 0.8                                   |       |       |       |       |                   | 0.8  |      |
|                                                                                        | TTL-CMOS  | 1                     |                        | 5                      | 15                     | 0.8                                   |       |       |       |       |                   | 0.8  |      |
|                                                                                        | CMOS-CMOS | 1                     |                        | 5                      | 10                     | 1.5                                   |       |       |       |       |                   | 1.5  |      |
|                                                                                        | CMOS-CMOS | 1.5                   |                        | 5                      | 15                     | 1.5                                   |       |       |       |       |                   | 1.5  |      |
|                                                                                        | CMOS-CMOS | 1.5                   |                        | 10                     | 15                     | 3                                     |       |       |       |       |                   | 3    |      |
| Input high voltage,<br>V <sub>IH</sub> min <sup>(1)</sup>                              | TTL-CMOS  | 9                     |                        | 5                      | 10                     | 2                                     |       |       |       | 2     |                   |      |      |
|                                                                                        | TTL-CMOS  | 13.5                  |                        | 5                      | 15                     | 2                                     |       |       |       | 2     |                   |      |      |
|                                                                                        | CMOS-CMOS | 9                     |                        | 5                      | 10                     | 3.5                                   |       |       |       | 3.5   |                   |      |      |
|                                                                                        | CMOS-CMOS | 13.5                  |                        | 5                      | 15                     | 3.5                                   |       |       |       | 3.5   |                   |      |      |
|                                                                                        | CMOS-CMOS | 13.5                  |                        | 10                     | 15                     | 7                                     |       |       |       | 7     |                   |      |      |
| Input current, I <sub>IN</sub> max                                                     |           |                       | 0, 18                  |                        | 18                     | ±0.1                                  | ±0.1  | ±1    | ±1    |       | ±10 <sup>−5</sup> | ±0.1 | μA   |

(1) Applies to the six input signals. For mode control (P13), only the CMOS-CMOS ratings apply.

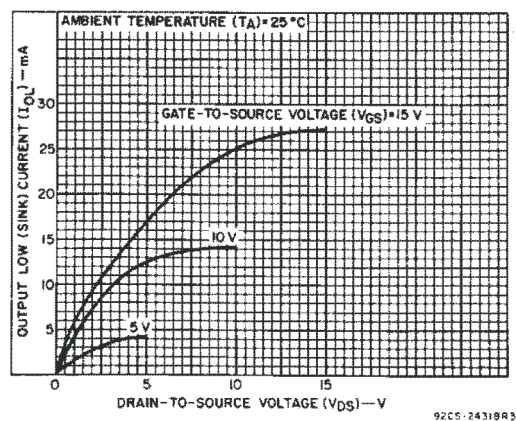


Figure 1. Typical Output Low (sink) Current Characteristics

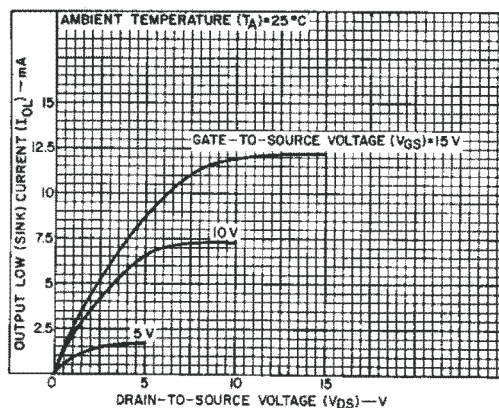


Figure 2. Minimum Output Low (sink) Current Characteristics

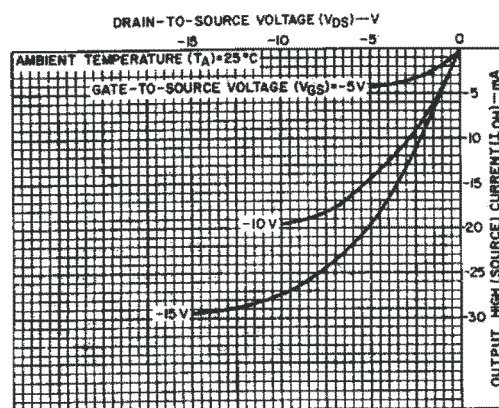
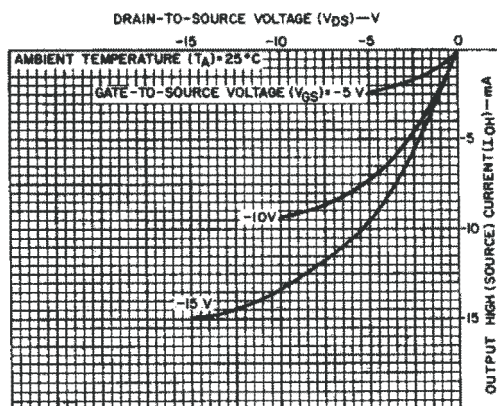


Figure 3. Typical Output High (source) Current Characteristics



**Figure 4. Minimum Output High (source) Current Characteristics**

## RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC                                                             | MIN | MAX | UNIT |
|----------------------------------------------------------------------------|-----|-----|------|
| $V_{DD}$ Supply-voltage range (for $T_A$ = full package temperature range) | 5   | 18  | V    |

## DYNAMIC ELECTRICAL CHARACTERISTICS

$T_A = 25^\circ\text{C}$ , Input  $t_r, t_f = 20\text{ ns}$ ,  $C_L = 50\text{ pF}$ ,  $R_L = 200\ \Omega$

| CHARACTERISTIC                            | SHIFTING MODE                     | $V_{CC}$<br>(V) | $V_{DD}$<br>(V) | LIMITS |     | UNIT |
|-------------------------------------------|-----------------------------------|-----------------|-----------------|--------|-----|------|
|                                           |                                   |                 |                 | TYP    | MAX |      |
| $t_{PHL}$ Propagation delay: high-to-low, | TTL to CMOS<br>$V_{DD} > V_{CC}$  | 5               | 10              | 140    | 280 | ns   |
|                                           |                                   | 5               | 15              | 140    | 280 |      |
|                                           |                                   | 5               | 10              | 120    | 240 |      |
|                                           | CMOS to CMOS<br>$V_{DD} > V_{CC}$ | 5               | 15              | 120    | 240 |      |
|                                           |                                   | 10              | 15              | 70     | 140 |      |
|                                           |                                   | 10              | 5               | 275    | 550 |      |
|                                           | CMOS to CMOS<br>$V_{CC} > V_{DD}$ | 15              | 5               | 275    | 550 |      |
|                                           |                                   | 15              | 10              | 70     | 140 |      |
|                                           |                                   | 15              | 10              | 70     | 140 |      |
| $t_{PLH}$ Propagation delay: low-to-high  | TTL to CMOS<br>$V_{DD} > V_{CC}$  | 5               | 10              | 140    | 280 | ns   |
|                                           |                                   | 5               | 15              | 140    | 280 |      |
|                                           |                                   | 5               | 10              | 120    | 240 |      |
|                                           | CMOS to CMOS<br>$V_{DD} > V_{CC}$ | 5               | 15              | 120    | 240 |      |
|                                           |                                   | 10              | 15              | 70     | 140 |      |
|                                           |                                   | 10              | 5               | 200    | 400 |      |
|                                           | CMOS to CMOS<br>$V_{CC} > V_{DD}$ | 15              | 5               | 200    | 400 |      |
|                                           |                                   | 15              | 10              | 60     | 120 |      |
|                                           |                                   | 15              | 10              | 60     | 120 |      |
| $t_{THL}, t_{TLH}$ Transition time        | All modes                         |                 | 5               | 100    | 200 | ns   |
|                                           |                                   |                 | 10              | 50     | 100 |      |
|                                           |                                   |                 | 15              | 40     | 80  |      |
| $C_{IN}$ Input capacitance                | Any input                         |                 |                 | 5      | 7.5 | pF   |

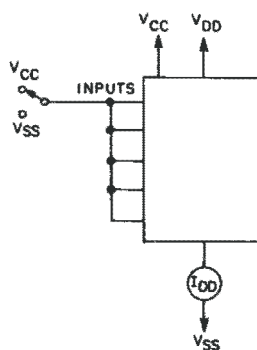


Figure 5. Quiescent Device Current

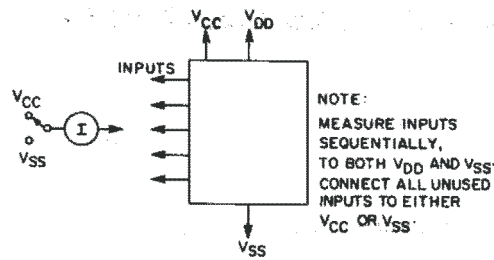


Figure 6. Input Current

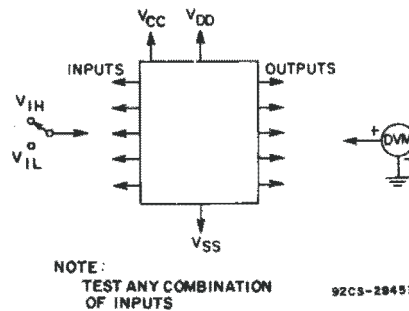


Figure 7. Input Voltage

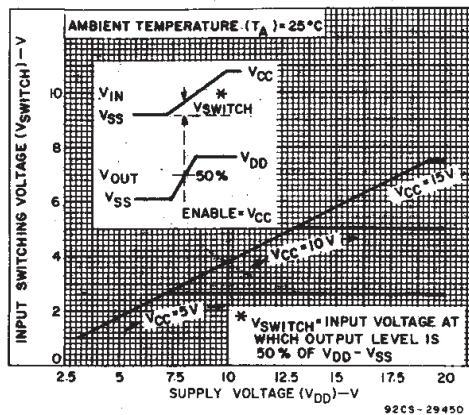


Figure 8. Typical Input Switching as a Function of High-Level Supply Voltage (SELECT at  $V_{CC}$  – CMOS Mode)

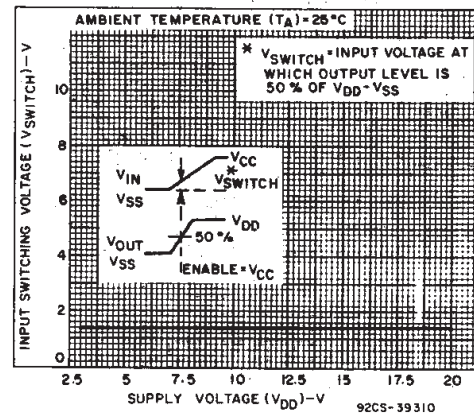


Figure 9. Typical Input Switching as a Function of High-Level Supply Voltage (SELECT at  $V_{SS}$  – TTL Mode)

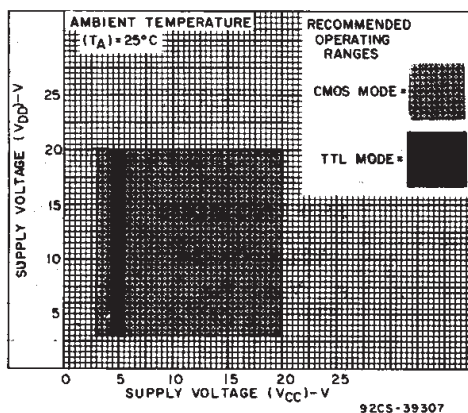
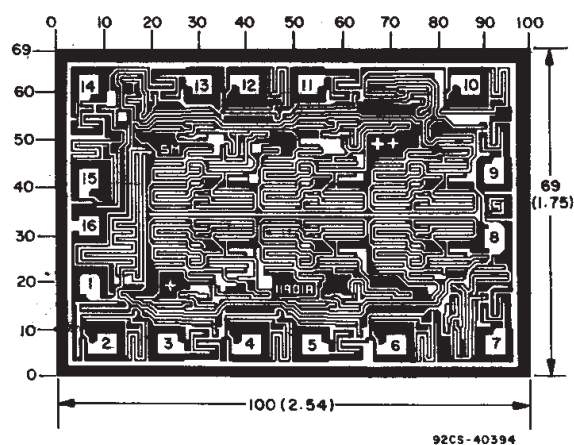


Figure 10. High-Level Supply Voltage vs. Low-Level Supply Voltage



- A. Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).

Figure 11. Dimensions and Pad Layout

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">CD4504BMPWREP</a>  | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | 4504BEP             |
| CD4504BMPWREP.A                | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | 4504BEP             |
| <a href="#">V62/09606-01XE</a> | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | 4504BEP             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

### OTHER QUALIFIED VERSIONS OF CD4504B-EP :

- Catalog : [CD4504B](#)

- Military : [CD4504B-MIL](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

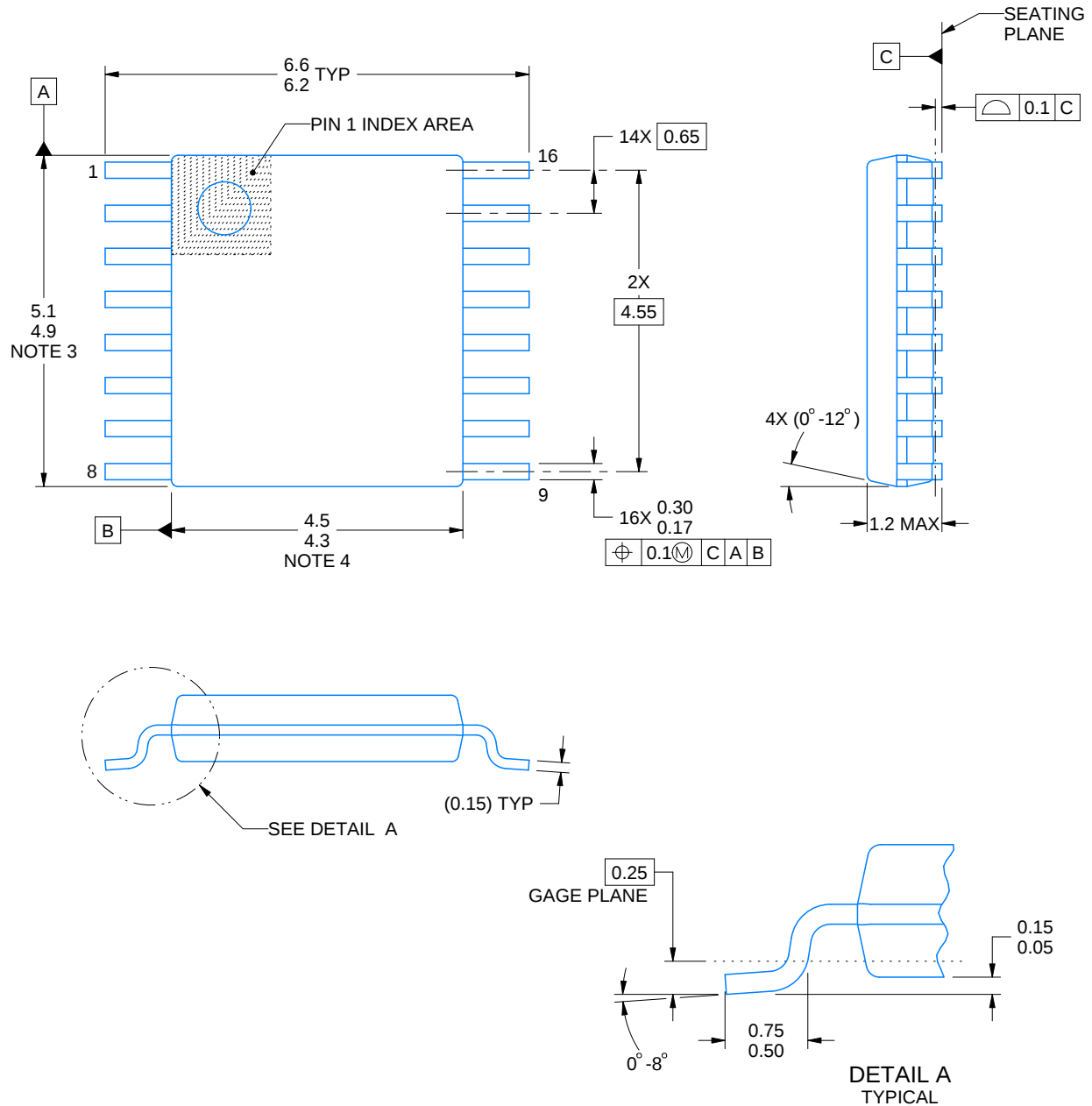
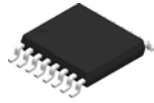
| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD4504BMPWREP | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD4504BMPWREP | TSSOP        | PW              | 16   | 2000 | 353.0       | 353.0      | 32.0        |



4220204/B 12/2023

## NOTES:

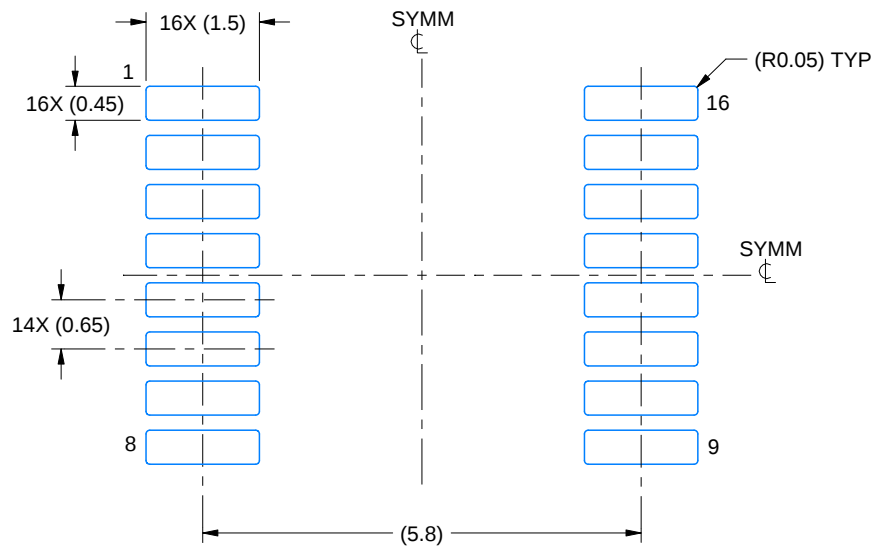
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

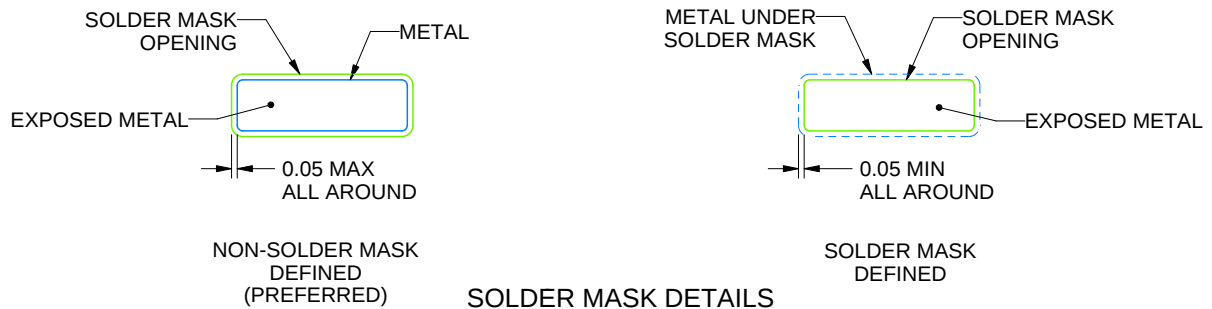
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220204/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220204/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2025, Texas Instruments Incorporated